

The research of the University of Bologna covers a wide range of issues:

## **Modeling & Characterization**

- Modelling and simulation aspects of micro/nano-electronic devices: simulation based on semiclassical microscopic transport models of nanoelectronic devices and quantum numerical simulation of nanoelectronic devices
- Organic/inorganic semiconducting materials and devices with applications on wearable devices, realized on non-conventional substrates
- Design of energy harvesting circuits and systems, with a special focus on micro-/nano-power scenarios
- Design of ultra-low power electronic systems
- Applications of piezoelectric transducers for real-time monitoring of physical properties of materials and objects

## Electronic design

- Innovative systems in health/energy/environmental monitoring, in industrial manufacturing/production and in food/agriculture
- Low power electronics and sensor to fit many application scenarios: design
  of high-accuracy and low-noise circuit interfaces for several types of
  sensors; design and characterization of capacitive sensors including custom
  implementations; design of integrated circuits and MEMS and energy
  autonomous sensor nodes for IoT; RFID systems; smart metering for smart grid/
  buildings applications and biosensors and lab-on-a-chip devices

## **HIGHLIGHTS**

The University of Bologna is member of the <u>AENEAS</u> - Association for European NanoElectronics Activities (Nanoelectronics R&D partners in the <u>ECSEL</u> JU).

At national level, it is member of <u>IUNET</u> - Inter-University Consortium for Nanoelectronics and of the Mirror Group <u>ECSEL ITALIA</u>.

The inter-department research center <u>ARCES</u> focused on Nanoelectronics, Microsystems and IoT hosts the **ARCES-ST joint Lab**, the industry-academia joint laboratory with STMicroelectronics Italia.

## **European funded projects**

H2020 FLAG-ERA <u>CONVERGENCE</u> - Frictionless Energy Efficient Convergent Wearables for Healthcare and Lifestyle Applications (2017-2020)

Partner of the following H2020 ECSEL projects:

R2POWER300 - Preparing R2 extension to 300mm for BCD Smart Power (2015-2018)

R3-PowerUP - 300mm Pilot Line for Smart Power and Power Discretes (2017-2021)

WINSIC4AP - Wide band gap Innovative SiC for Advanced Power (2017-2020)

**CONNECT** - Innovative smart components, modules and appliances for a truly connected, efficient and secure smart grid (2017-2020)

REACTION - first and euRopEAn siC eigTh Inches pilOt liNe (2018-2022)

AI4DI (2019-2022)

iRel40 - Intelligent Reliability 4.0 (2020-2023)